

## .079" (2.00mm) Center Wafer Assembly

### 6600 Series

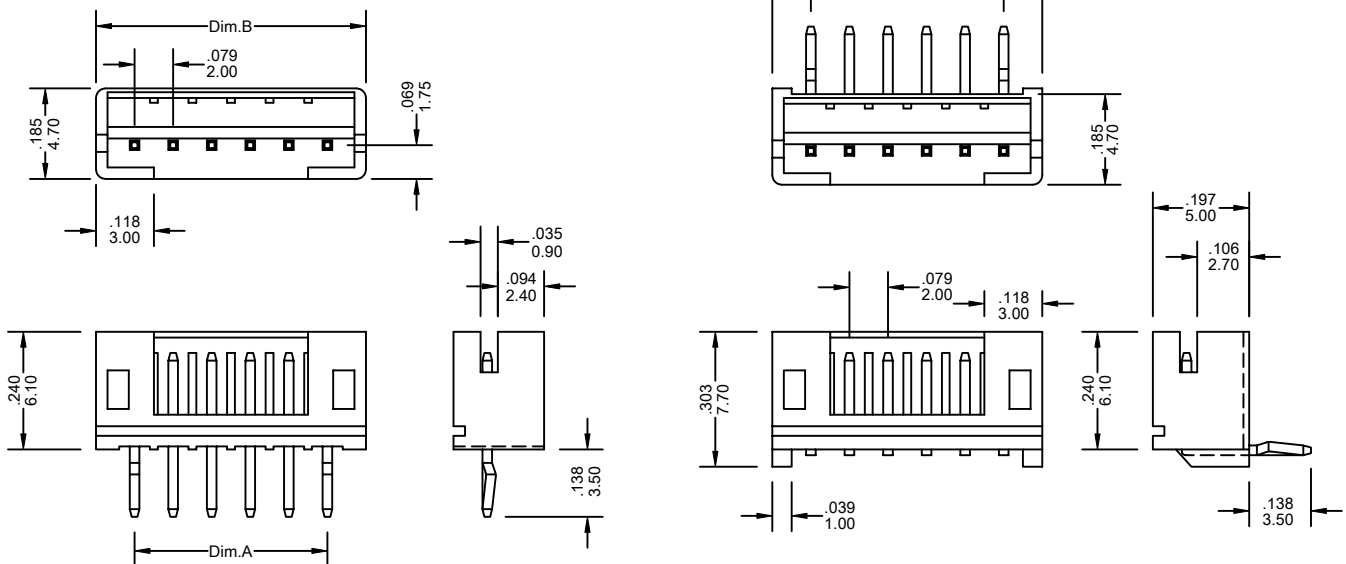
#### FEATURES:

- . 2-20 Circuits
- . Friction lock
- . Nylon [UL 94V-0]
- . Accepts double cantilever crimp terminal
- . Mates with 6000 series

#### SPECIFICATIONS:

- . Current rating: 2A AC. DC
- . Voltage rating: 250V AC. Maximum
- . Temperature range: -40°C ~+ 105°C
- . Contact resistance: Initial Value/10mΩ max.  
After environmental testing /20mΩ max.
- . Insulation resistance: 5000 MΩ min
- . Withstand Voltage: 1500V AC/minute
- . Applicable PC board thickness: .063"[1.6mm]

UNIT: INCH  
MM

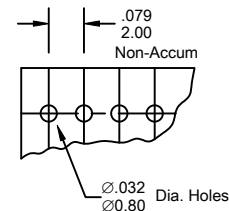


(S: Straight)

(R: Right Angle)

### Ordering Information 6600 Series

Series No.	No. of Contacts	Contact Type	Contact Plating	
6600	- 06P	S	T	- PB
6600 Series	02P ~ 20P	S: Straight R: Right Angle	T: Tin G1: Gold Flash G5: 5u" Gold G10: 10u" Gold G15: 15u" Gold G30: 30u" Gold [G: Full Gold]	RoHs



Recommended P.C. Board Hole Dimensions

### Dimensional Information

Circuits	Dim.A± .008 0.20	Dim.B± .008 0.20	Circuits	Dim.A± .008 0.20	Dim.B± .008 0.20	Circuits	Dim.A± .008 0.20	Dim.B± .008 0.20
2	.079 2.00	.236 6.00	3	.157 4.00	.315 8.00	4	.236 6.00	.394 10.00

6600 Series

\* FOR CIRCUIT SIZES 5 THROUGH 20 ADD .079" OR 2.00MM FOR EACH ADDITIONAL PIN.